8. Mechanical Instruction

- 8.1 Disassembly Procedures
- S1 Turn off power
- S2 Push the button to remove the stand-base assy.





Remove the screw to remove the stand assy and the base assy.





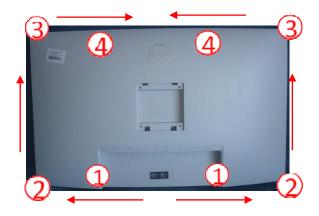


Use a Philips-head screwdriver to remove 4 screws for unlocking mechanisms.

(No.1~4 screw size=M4x10; Torque: 12±2kgf.cm)



Wedge your fingers between the rear cover and the middle bezel on the corners of the top side of the monitor to release the rear cover, then use one hand to press the middle bezel, the other hand to pull up carefully the rear cover in order of arrow preference for unlocking mechanisms of rear cover

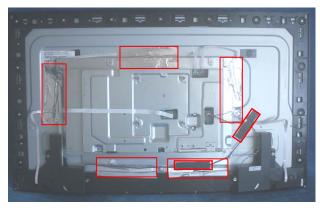


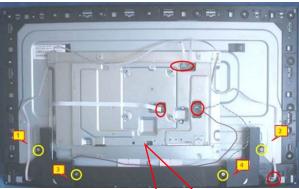


Tear off 5 pieces of aluminum foil and 2 pieces of tapes. Disconnect the lamp cable from the connectors of the power board and panel module. Use a Philips-head screwdriver to remove 4 screws for unlocking the speakers.

(No.1~4 Screw size=M3x6, Torque: 4±1kgf.cm)

S6







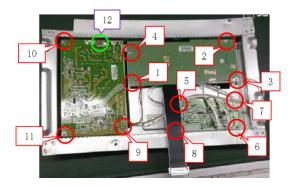
Remove the Mylar. Use a Philips-head screwdriver to remove 12 screws for unlocking the main board and the adapter board

(No.1~11 screw size=D3x6, Torque: 6±1kgf.cm)

S7

(No.12 screw size=M4x6, Torque: 6±1kgf.cm)





S8 Disconnect all of the cables.

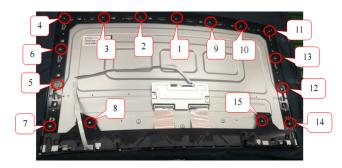


S9 The Mainframe



Use a Philips-head screwdriver to remove 15 screws for unlocking the middle plastic bezel with the whole unit, and then remove the middle plastic bezel carefully.

(No.1~15 screw size=M3x4, Torque=3±0.5kgfxcm)





Use a Philips-head screwdriver to remove 3 screws to remove the key board.

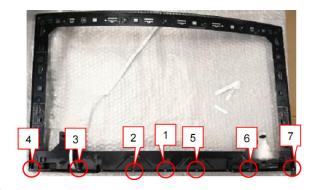
(No.1~3 screw size=M6x19, Torque=0.9±0.4kgf.cm)



Use a Philips-head screwdriver to remove 7

S12 screws for unlocking the BEZEL_BTM and the Panel.

(No.1~7 screw size=M6x19, Torque=0.9±0.4kgf.cm)

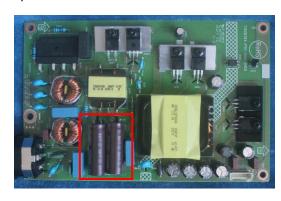


S₁₃ The middle frame and the DECO bezel.

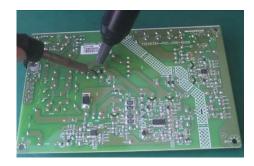




Remove electrolyte capacitors (red mark) from printed circuit boards.



Take out bulk cap. Pins older with soldering iron and absorber.



Lift the bulk cap. up and away from the PCB



8.2 Product material information

The following substances, preparations, or components should be disposed of or recovered separately from other WEEE in compliance with Article 4 of EU Council Directive 75/442/EEC.

Capacitors / condensers (containing	No used
PCB/PCT)	
Mercury containing components	No used
Batteries	No used
Printed circuit boards (with a surface	Product has printed circuit boards (with a
greater than 10 square cm)	surface greater than 10 square cm)
Component contain toner, ink and liquids	No used
Plastic containing BFR	No used
Component and waste contain asbestos	No used
CRT	No used
Component contain CFC, HCFC, HFC	No used
and HC	
Gas discharge lamps	No used
LCD display > 100 cm2	Product has an LCD greater than 100
	cm2
External electric cable	Product has external cables
Component contain refractory ceramic	No used
fibers	
Component contain radio-active	No used
substances	
Electrolyte capacitors (height	Product has electrolyte capacitors
> 25mm, diameter > 25mm)	(height > 25mm, diameter > 25mm)

8.3 Tools Required

List the type and size of the tools that would typically can be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description:

- Screwdriver (Phillip head) #1
- Screwdriver (Phillip head) #2
- Penknife
- Soldering iron and absorber